



(2.00 mm) .0787"

UDED IDC EJECTOR HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?EHT

Insulator Material:

Black Liquid Crystal Polymer Terminal Material:

Phosphor Bronze

Phospion Bronze
Plating:
Sn or Au over
50 µ" (1.27 µm) Ni
Operating Temp Range:
-55 °C to +125 °C
RHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality

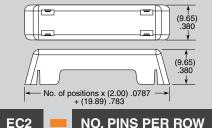


ALSO AVAILABLE (MOQ Required)

 Other platings Contact Samtec. Mates with:

Ten standard sizes mate with common 2 mm IDC cable assemblies

EJECTOR HEADER CAP (Locks TCSD cable to EHT header)



05, 08, 10, 12, 13,

Ejector latches Straight through-hole, right-angle, or surface mount

15, 17, <u>20, 22, 25</u> NO. PINS

PER ROW

PLATING 01 **OPTION**

OPTION

OTHER OPTION

05, 08, 10, 12, 13, 15, 17, 20, 22, 25

= Gold flash on post, Matte Tin on tail

= 10 µ" (0.25 µm) Gold on post,

Leave blank for Through-hole

> -RA = Right-angle

-SM

-RA

(Latch removed for clarity)

¹(1.52) .060



-SR = Strain Relief (Leave Blank for no strain relief)

-LC

= Locking Clip (-SM only) (Manual placement required)

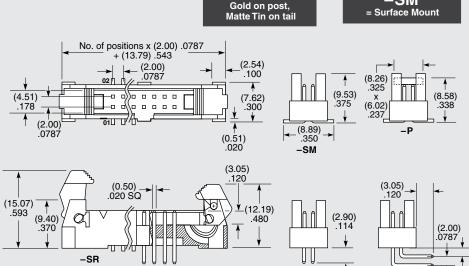
= (6.50 mm) .256" DIÀ Polyimide Film Pick & Place Pad (-SM only)

-P

= Pick & Place Pad (-SM only)

-TR

=Tape & Reel (-SM only)



Note: Some lengths, styles and options are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice. WWW.SAMTEC.COM